L Number	Hits	Search Text	DB	Time stamp
-	428	(MIM or (metal adj insulator adj metal)) adj capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 11:52
-	21	((MIM or (metal adj insulator adj metal)) adj capacitor) and (etch adj stop)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 14:37
-	6987	stop adj layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 14:39
-	20	(stop adj layer) and ((MIM or (Metal adj insulator adj metal)) adj capacitor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 14:46
-	1433	substrate and (dielectric adj layer) and ((stop adj layer) or (etch adj back)) and (metal adj layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 14:49
-	230	(substrate and (dielectric adj layer) and ((stop adj layer) or (etch adj back)) and (metal adj layer)) and (dual adj damascene)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 14:49
-	4	((substrate and (dielectric adj layer) and ((stop adj layer) or (etch adj back)) and (metal adj layer)) and (dual adj damascene)) and MIM	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 14:53
-	4041	MIM	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 14:54
-	76	MIM and ((stop adj layer) or (etch adj back))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 15:05
-	730	(dielectric adj layer) near3 copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 15:37
-	0	((dielectric adj layer) near3 copper) and ((dielectic adj layer) near3 substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 15:37
-	6	((dielectric adj layer) near3 copper) and MIM	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 15:38
-	567	(stop adj layer) near3 (dielectric adj layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 15:43

-	40	((stop adj layer) near3 (dielectric adj layer)) and (copper near4 (dielectric adj layer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 16:11
-	1668	dual adj damascene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 16:11
-	486	(dual adj damascene) and (stop adj layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 16:12
-	395	((dual adj damascene) and (stop adj layer)) and (dielectric adj layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 16:13
-	58	(((dual adj damascene) and (stop adj layer)) and (dielectric adj layer)) and (etch adj back)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 16:14

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